

# MOS FIELD EFFECT TRANSISTOR $\mu PA1858$

### P-CHANNEL MOS FIELD EFFECT TRANSISTOR FOR SWITCHING

#### DESCRIPTION

The  $\mu$ PA1858 is a switching device, which can be driven directly by a 2.5 V power source.

This device features a low on-state resistance and excellent switching characteristics, and is suitable for applications such as power management of portable machine and so on.

#### **FEATURES**

- 2.5 V drive available
- Low on-state resistance  $R_{DS(on)1} = 24.5 \text{ m}\Omega \text{ MAX}. (V_{GS} = -4.5 \text{ V}, \text{ ID} = -2.5 \text{ A})$   $R_{DS(on)2} = 25.5 \text{ m}\Omega \text{ MAX}. (V_{GS} = -4.0 \text{ V}, \text{ ID} = -2.5 \text{ A})$  $R_{DS(on)3} = 38 \text{ m}\Omega \text{ MAX}. (V_{GS} = -2.5 \text{ V}, \text{ ID} = -2.5 \text{ A})$
- Built-in G-S protection diode against ESD

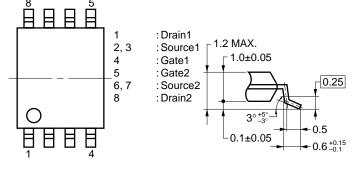
#### ORDERING INFORMATION

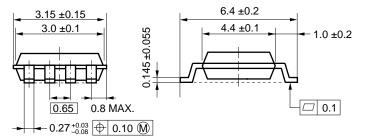
PART NUMBER	PACKAGE
μPA1858GR-9JG	Power TSSOP8

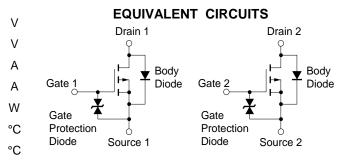
#### ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (Vgs = 0 V)	VDSS	-20	
Gate to Source Voltage (VDS = 0 V)	Vgss	∓12	
Drain Current (DC)	ID(DC)	∓5.0	
Drain Current (pulse) <sup>Note1</sup>	D(pulse)	∓20	
Total Power Dissipation (2 units) Note2			
Channel Temperature	Tch	150	
Storage Temperature	Tstg	–55 to +150	

## PACKAGE DRAWING (Unit: mm)







**Notes 1.** PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1%

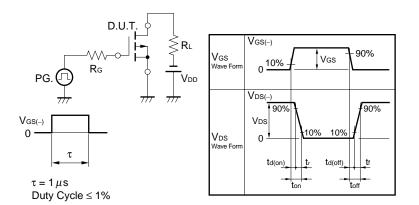
- 2. Mounted on ceramic substrate of 5000 mm<sup>2</sup> x 1.1 mm
- **Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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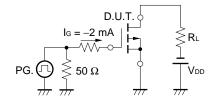
ELECTRICAL CHARACTERISTICS (TA = 25°C)

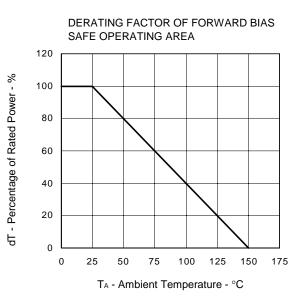
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = -20 V, V_{GS} = 0 V$			-1.0	μA
Gate Leakage Current	lgss	$V_{GS} = \mp 12 V$ , $V_{DS} = 0 V$			∓10	μA
Gate Cut-off Voltage	V <sub>GS(off)</sub>	$V_{DS} = -10 V$ , $I_{D} = -1.0 mA$	-0.5	-1.0	-1.5	V
Forward Transfer Admittance	y <sub>fs</sub>	$V_{DS} = -10 V$ , $I_D = -2.5 A$	5.0	14.2		S
Drain to Source On-state Resistance	RDS(on)1	$V_{GS} = -4.5 \text{ V}, \text{ Id} = -2.5 \text{ A}$		20.3	24.5	mΩ
	RDS(on)2	$V_{GS} = -4.0 \text{ V}, \text{ Id} = -2.5 \text{ A}$		21.1	25.5	mΩ
	RDS(on)3	$V_{GS} = -2.5 V$ , $I_D = -2.5 A$		28.5	38	mΩ
Input Capacitance	Ciss	V <sub>DS</sub> = -10 V		1300		pF
Output Capacitance	Coss	V <sub>GS</sub> = 0 V		300		pF
Reverse Transfer Capacitance	Crss	f = 1.0 MHz		180		pF
Turn-on Delay Time	td(on)	$V_{DD} = -10 V$ , $I_D = -2.5 A$		16		ns
Rise Time	tr	Vgs = -4.0 V		65		ns
Turn-off Delay Time	td(off)	R <sub>G</sub> = 10 Ω		115		ns
Fall Time	tr			125		ns
Total Gate Charge	Q <sub>G</sub>	$V_{DD} = -16 V$		12		nC
Gate to Source Charge	QGS	Vgs = -4.0 V		1.5		nC
Gate to Drain Charge	Qgd	ID = -5.0 A		5.0		nC
Body Diode Forward Voltage	VF(S-D)	IF = 5.0 A, VGS = 0 V		0.81		V
Reverse Recovery Time	trr	IF = 5.0 A, VGS = 0 V		90		ns
Reverse Recovery Charge	Qrr	di/dt = 50 A /µs		62		nC

#### **TEST CIRCUIT 1 SWITCHING TIME**



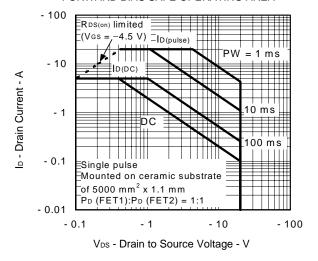
#### **TEST CIRCUIT 2 GATE CHARGE**



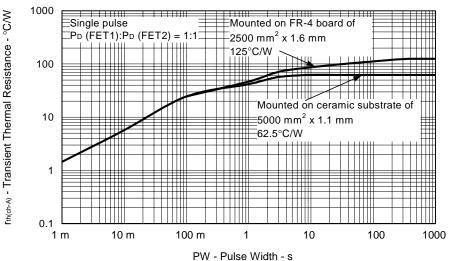


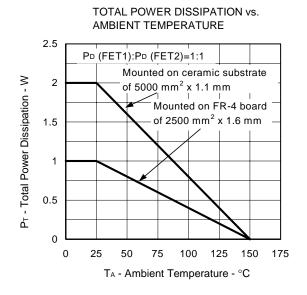
#### **TYPICAL CHARACTERISTICS (TA = 25^{\circ}C)**

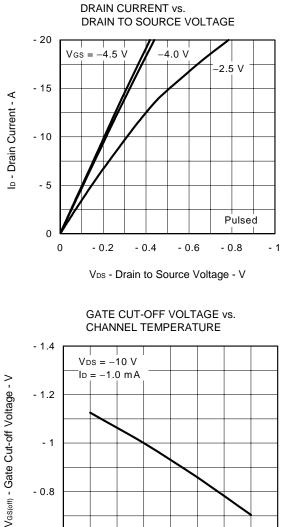


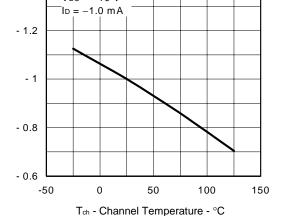


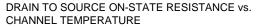


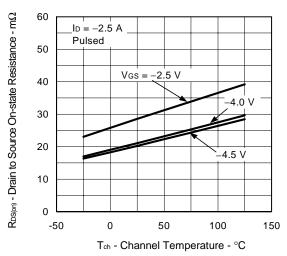




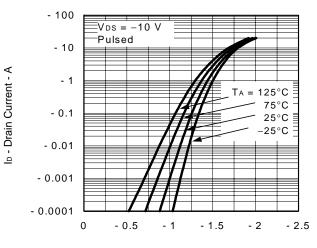






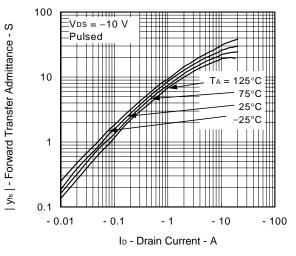


FORWARD TRANSFER CHARACTERISTICS

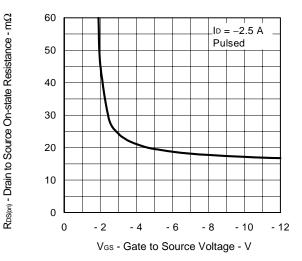


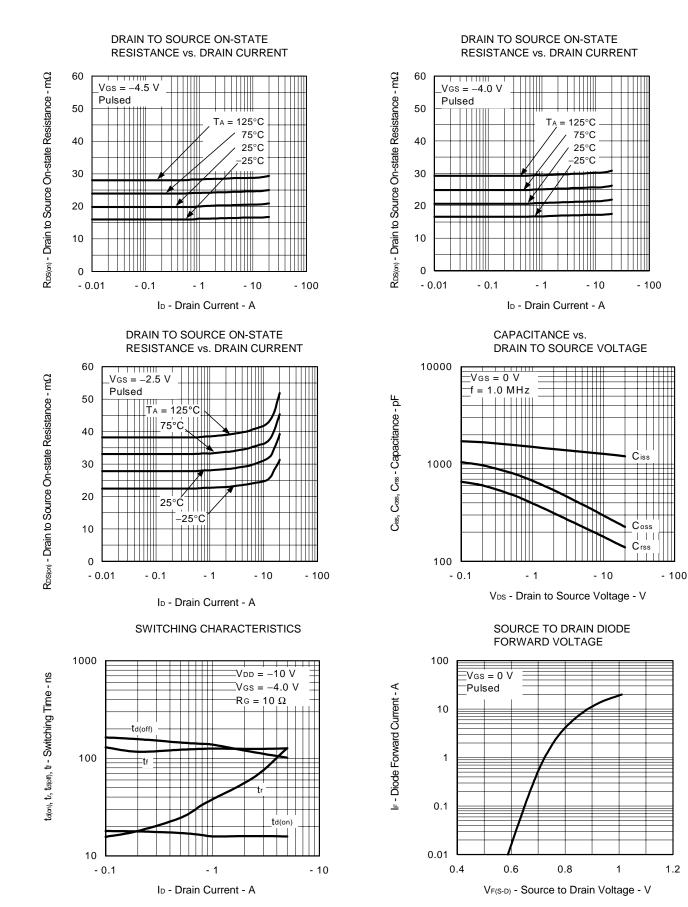


FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT

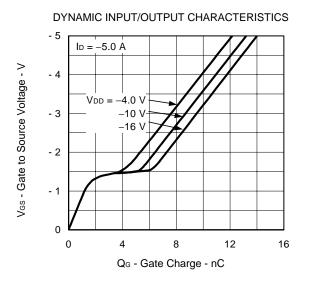


DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE





Data Sheet G16276EJ1V0DS



[MEMO]

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